MMBT2222ATT1

NPN Silicon

These transistors are designed for general purpose amplifier applications. They are housed in the SC-89 package which is designed for low power surface mount applications.

Features

We declare that the material of product compliance with RoHS requirements.

Pb-Free package is available

RoHS product for packing code suffix "G"
Halogen free product for packing code suffix "H"
Moisture Sensitivity Level 1

ORDERING INFORMATION

Device	Maring	Shipping
MMBT2222ATT1	1P	3000 / Tape & Reel

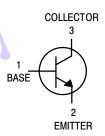
MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V _{CEO}	40	Vdc
Collector-Base Voltage	V _{CBO}	75	Vdc
Emitter-Base Voltage	V _{EBO}	6.0	Vdc
Collector Current - Continuous	Ic	600	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation (Note 1) T _A = 25°C	P _D	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	833	°C/W
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

SC-89



MARKING DIAGRAM



1P = Specific Device Code M = Date Code

= Pb-Free Package

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS	<u>.</u>			•
Collector – Emitter Breakdown Voltage (Note 1) (I _C = 1.0 mAdc, I _B = 0)	V _{(BR)CEO}	40	-	Vdc
Collector – Base Breakdown Voltage $(I_C = 10 \mu Adc, I_E = 0)$	V _{(BR)CBO}	75	-	Vdc
Emitter – Base Breakdown Voltage (I_E = 10 μ Adc, I_C = 0)	V _{(BR)EBO}	6.0	-	Vdc
Base Cutoff Current (V _{CE} = 60 Vdc, V _{EB} = 3.0 Vdc)	I _{BL}	-	20	nAdc
Collector Cutoff Current (V _{CE} = 60 Vdc, V _{EB} = 3.0 Vdc)	I _{CEX}	-	100	nAdc



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ON CHARACTERISTICS (Note 2)

DC Current Gain	H _{FE}			_
$(I_C = 0.1 \text{ mAdc}, V_{CE} = 10 \text{ Vdc})$		35	_	
$(I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc})$		50	_	
$(I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc})$		75	_	
$(I_C = 150 \text{ mAdc}, V_{CE} = 10 \text{ Vdc})$		100	_	
$(I_C = 500 \text{ mAdc}, V_{CE} = 10 \text{ Vdc})$		40	_	
Collector - Emitter Saturation Voltage	V _{CE(sat)}			Vdc
$(I_C = 150 \text{ mAdc}, I_B = 15 \text{ mAdc})$	` ′	_	0.3	
$(I_C = 500 \text{ mAdc}, I_B = 50 \text{ mAdc})$		-	1.0	
Base - Emitter Saturation Voltage	V _{BE(sat)}			Vdc
$(I_C = 150 \text{ mAdc}, I_B = 15 \text{ mAdc})$	` ′	0.6	1.2	
(I _C = 500 mAdc, I _B = 50 mAdc)	.4	-	2.0	
SMALL-SIGNAL CHARACTERISTICS				

Current-Gain - Bandwidth Product (I _C = 20 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)	f _T	250	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz)	C _{obo}	-	8.0	pF
Input Capacitance (V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MHz)	C _{ibo}	-	30	pF
Input Impedance (V _{CE} = 10 Vdc, I _C = 10 mAdc, f = 1.0 kHz)	h _{ie}	0.25	1.25	kΩ
Voltage Feedback Ratio (V _{CE} = 10 Vdc, I _C = 10 mAdc, f = 1.0 kHz)	h _{re}	-	4.0	X 10 ⁻⁴
Small – Signal Current Gain (V _{CE} = 10 Vdc, I _C = 10 mAdc, f = 1.0 kHz)	h _{fe}	75	375	-
Output Admittance (V _{CE} = 10 Vdc, I _C = 10 mAdc, f = 1.0 kHz)	h _{oe}	25	200	μmhos
Noise Figure (V_{CE} = 10 Vdc, I_{C} = 100 μ Adc, R_{S} = 1.0 k ohms, f = 1.0 kHz)	NF	-	4.0	dB

SWITCHING CHARACTERISTICS

Delay Time	$(V_{CC} = 3.0 \text{ Vdc}, V_{BE} = -0.5 \text{ Vdc},$	t _d	-	10	no
Rise Time	$I_C = 150 \text{ mAdc}, I_{B1} = 15 \text{ mAdc})$	t _r	-	25	ns
Storage Time	(V _{CC} = 30 Vdc, I _C = 150 mAdc,	t _s	_	225	ns
Fall Time	I _{B1} = I _{B2} = 15 mAdc)	t _f	-	60	115

^{1.} Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.

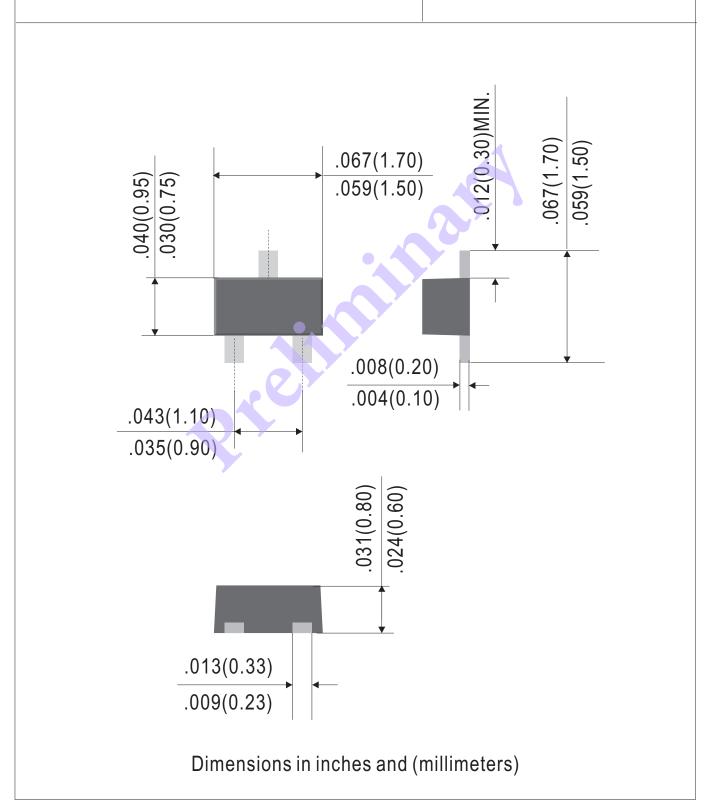
^{2.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.





Outline Drawing

SC-89





Ordering Information:

Device PN	Packing
MMBT2222ATT1 G ⁽¹⁾ -WS	Tape&Reel: 3 Kpcs/Reel

Note: (1) RoHS product for packing code suffix "G"; Halogen free product for packing code suffix "H"

Disclaimer

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